

**Amendments to the Claims:**

This listing of claims will replace the listing of claims as pending in the present application:

**Listing of Claims:**

Claim 1 (original): A copper alloy sputtering target containing 0.01 to (less than) 0.5wt% of at least 1 element selected from Al or Sn, and containing either Mn or Si or both in a total amount of 0.25wtppm or less.

Claims 2-15 (canceled).